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Contents

LASER DIODE COMPONENTS AND PACKAGING I

- 11667 03 **Ultra-high peak power laser diode arrays with 1kA-class low-SWaP drive electronics** [11667-1]
- 11667 05 **Collimation performance measurement of FAC lenses by active and automated alignment**
[11667-3]

LASER DIODE COMPONENTS AND PACKAGING II

- 11667 0A **Thermal characteristics analysis of high power 808nm bar facial array** [11667-8]
- 11667 0C **Single mode 660 nm master-oscillator power-amplifier with 500 mW optical output power**
[11667-10]

HIGH POWER/ENERGY LASER COMPONENTS AND PACKAGING I

- 11667 0F **High energy ultrashort pulse delivery through hollow-core photonic crystal fiber** [11667-13]
- 11667 0G **Influence of the piezoelectric ringing on the polarisation contrast of the KRTP Pockels cell in the modulation frequency range up to 10 MHz** [11667-14]

HIGH POWER/ENERGY LASER COMPONENTS AND PACKAGING II

- 11667 0I **Optimization of kW-class fiber splices and packages for ultra-high-power applications**
[11667-16]
- 11667 0J **Pump combiner with chirally coupled core fibers for side pumped single frequency all fiber amplifiers** [11667-17]
- 11667 0K **USP laser with integrated fiber beam delivery for micromachining** [11667-18]

POSTER SESSION

- 11667 0L **Quasi-monolithic laser system based on 3D-printed optomechanics** [11667-19]